



# SPN3458

## N-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SPN3458 is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

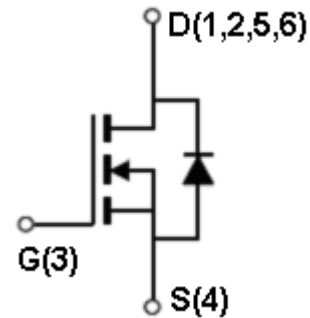
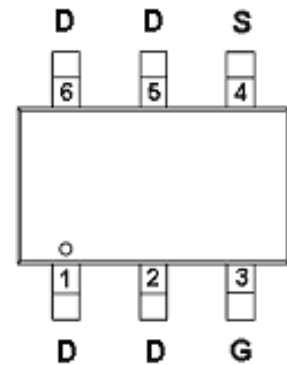
### FEATURES

- ◆ 60V/5.0A,  $R_{DS(ON)}=115m\Omega@V_{GS}=10V$
- ◆ 60V/4.5A,  $R_{DS(ON)}=125m\Omega@V_{GS}=4.5V$
- ◆ Super high density cell design for extremely low  $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOT-23-6L package design

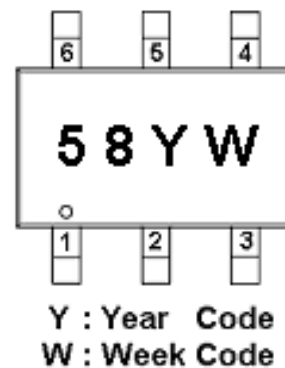
### APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

### PIN CONFIGURATION(SOT-23-6L)



### PART MARKING





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### PIN DESCRIPTION

Pin	Symbol	Description
1	D	Drain
2	D	Drain
3	G	Gate
4	S	Source
5	D	Drain
6	D	Drain

### ORDERING INFORMATION

Part Number	Package	Part Marking
SPN3458S26RGB	SOT-23-6L	58

※ Week Code : A ~ Z( 1 ~ 26 ) ; a ~ z( 27 ~ 52 )

※ SPN3458S26RGB : Tape Reel ; Pb – Free ; Halogen – Free

### ABSOLUTE MAXIMUM RATINGS

( $T_A=25^{\circ}\text{C}$  Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	$V_{DSS}$	60	V	
Gate –Source Voltage	$V_{GSS}$	$\pm 20$	V	
Continuous Drain Current( $T_J=150^{\circ}\text{C}$ )	$I_D$	$T_A=25^{\circ}\text{C}$	5.0	A
		$T_A=70^{\circ}\text{C}$	4.0	
Pulsed Drain Current	$I_{DM}$	10	A	
Continuous Source Current(Diode Conduction)	$I_S$	2.0	A	
Power Dissipation	$P_D$	$T_A=25^{\circ}\text{C}$	2.0	W
		$T_A=70^{\circ}\text{C}$	1.3	
Operating Junction Temperature	$T_J$	150	$^{\circ}\text{C}$	
Storage Temperature Range	$T_{STG}$	-55/150	$^{\circ}\text{C}$	
Thermal Resistance-Junction to Ambient	$R_{\theta JA}$	90	$^{\circ}\text{C}/\text{W}$	



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### ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

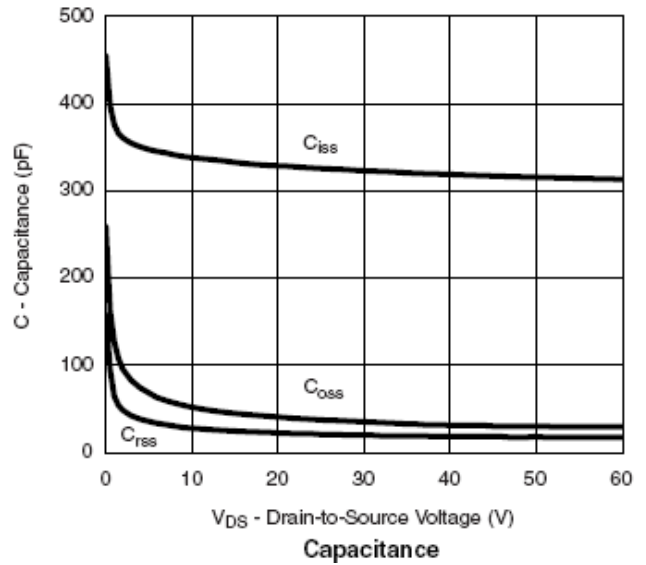
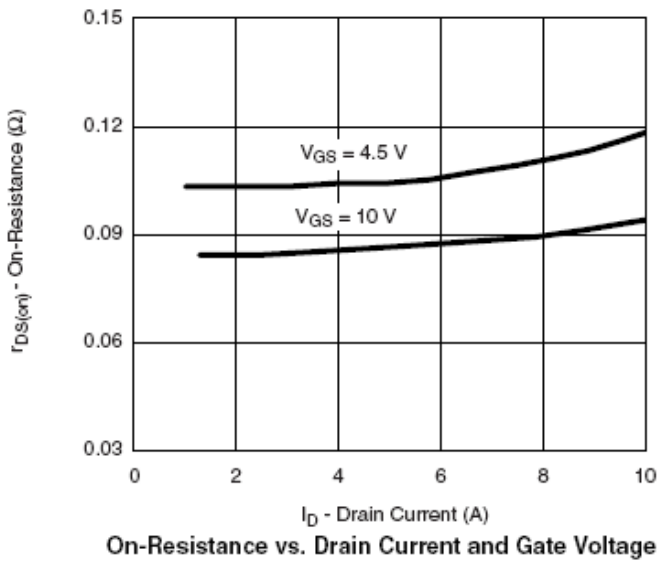
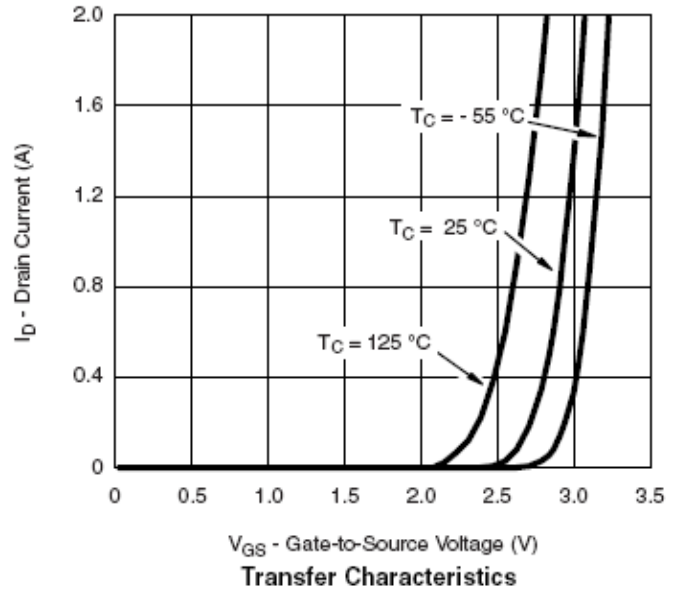
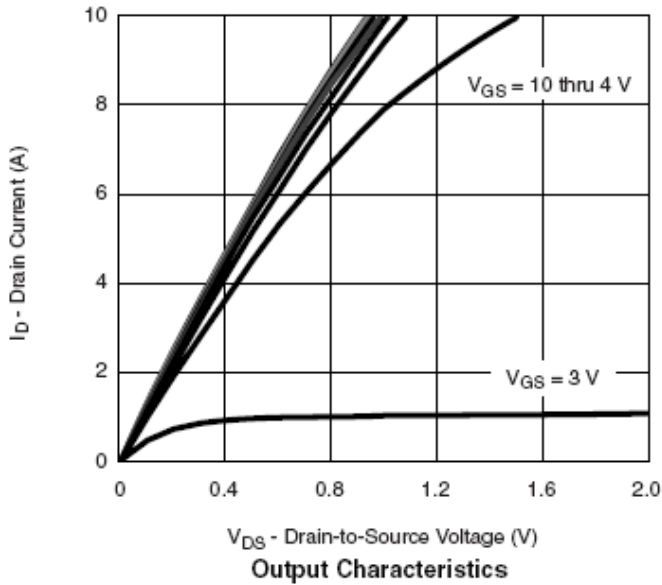
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	60			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5		1.5	
Gate Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 20V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=60V, V_{GS}=0.0V$			1	uA
		$V_{DS}=60V, V_{GS}=0.0V$ $T_J=55^\circ C$			10	
On-State Drain Current	$I_{D(on)}$	$V_{DS} \geq 4.5V, V_{GS}=4.5V$	10			A
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D=5.0A$		0.106	0.115	$\Omega$
		$V_{GS} = 4.5V, I_D=4.5A$		0.118	0.125	
Forward Transconductance	$g_{fs}$	$V_{DS}=15V, I_D=4.0A$		12		S
Diode Forward Voltage	$V_{SD}$	$I_S=2.5A, V_{GS}=0V$		0.8	1.2	V
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=30V, V_{GS}=4.5V$ $I_D=4.0A$		4.0	6	nC
Gate-Source Charge	$Q_{gs}$			1.2		
Gate-Drain Charge	$Q_{gd}$			1.0		
Input Capacitance	$C_{iss}$	$V_{DS}=30V, V_{GS}=0V$ $f=1MHz$		320		pF
Output Capacitance	$C_{oss}$			42		
Reverse Transfer Capacitance	$C_{rss}$			20		
Turn-On Time	$t_{d(on)}$	$V_{DD}=30V, R_L=12\Omega$ $I_D=2.5A, V_{GEN}=10V$ $R_G=6\Omega$		6	10	nS
	$t_r$			12	20	
Turn-Off Time	$t_{d(off)}$			18	30	
	$t_f$			10	15	



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### TYPICAL CHARACTERISTICS

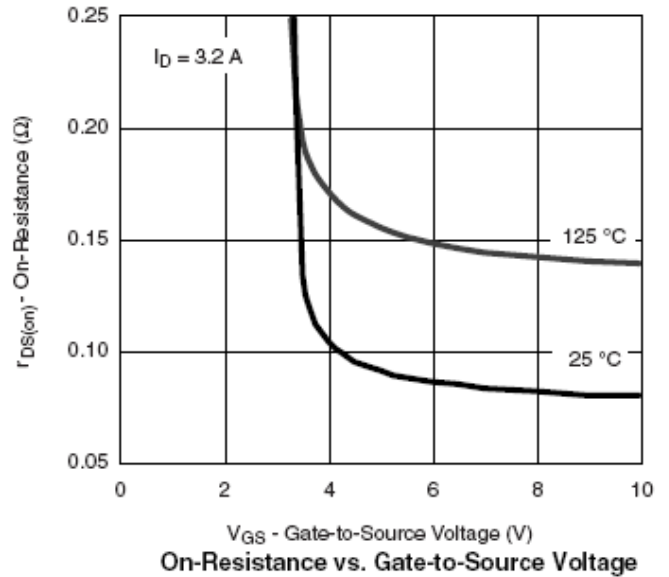
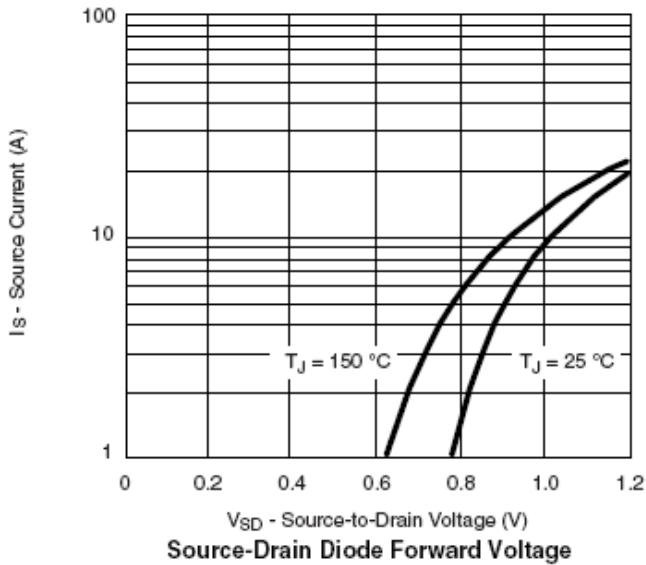
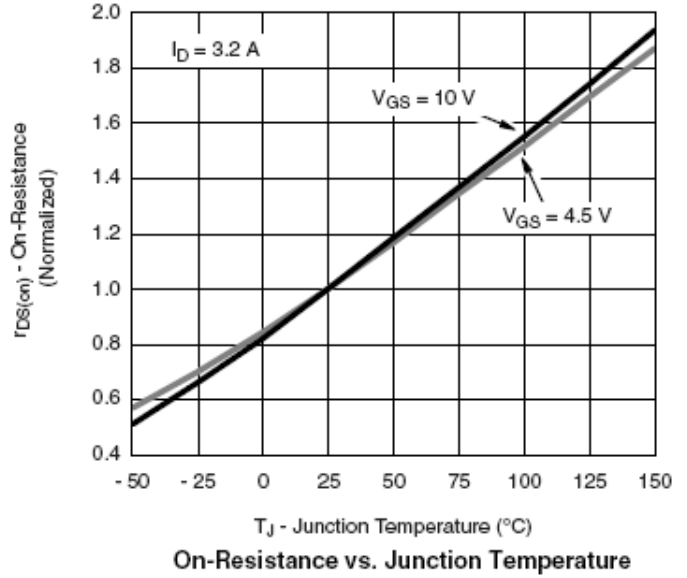
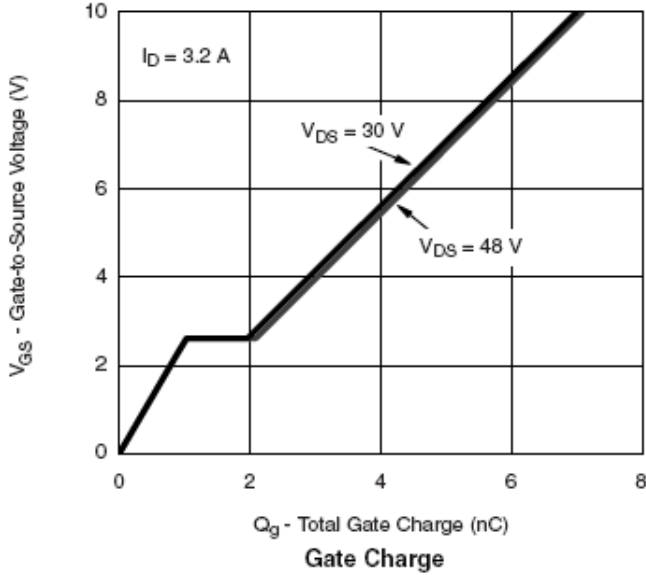




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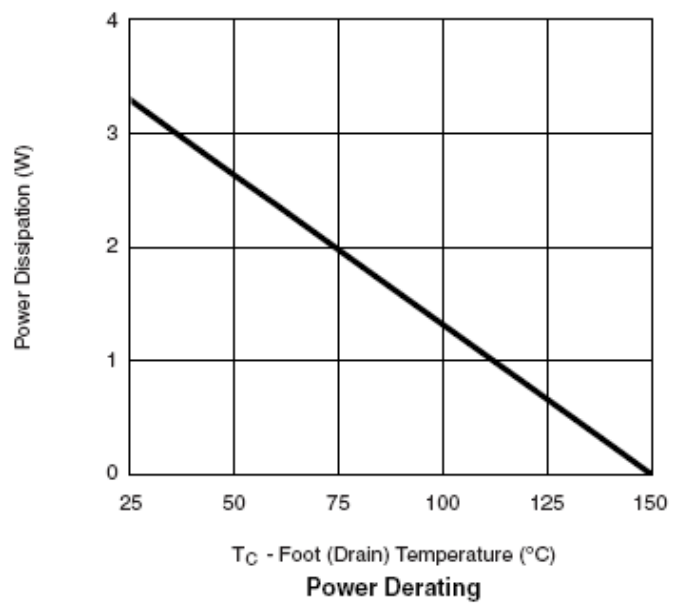
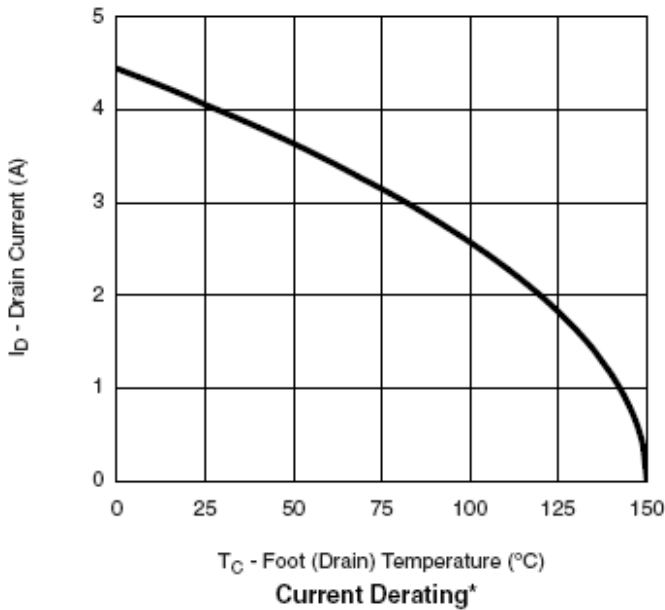
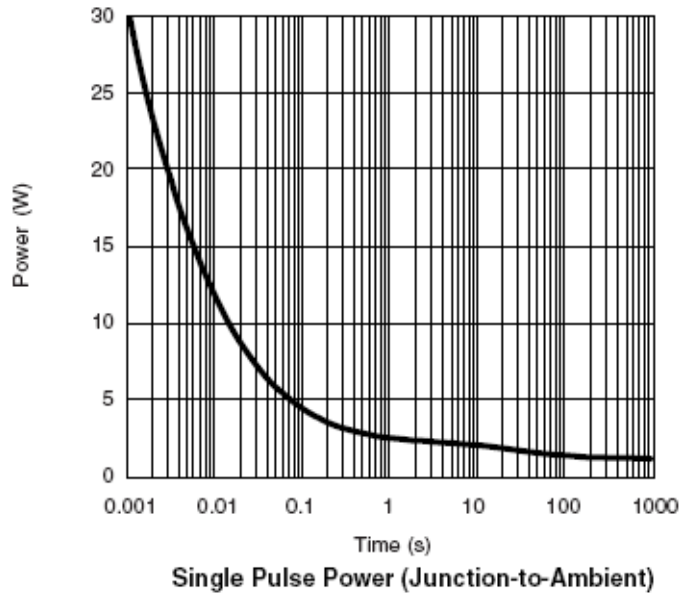
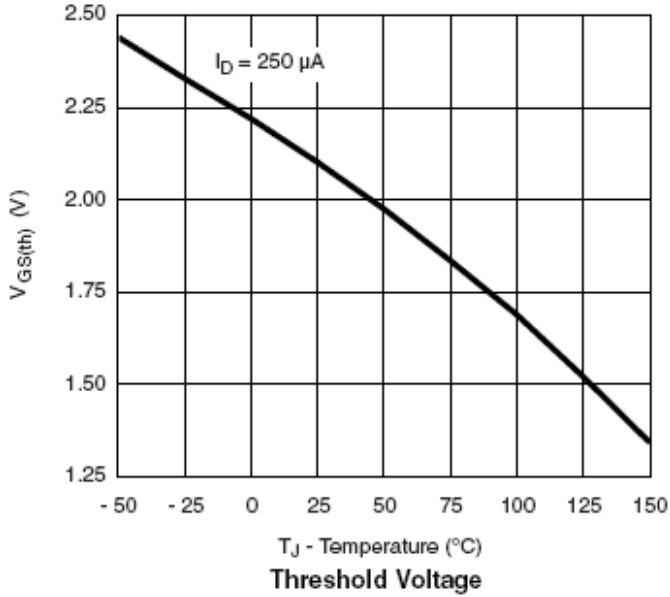
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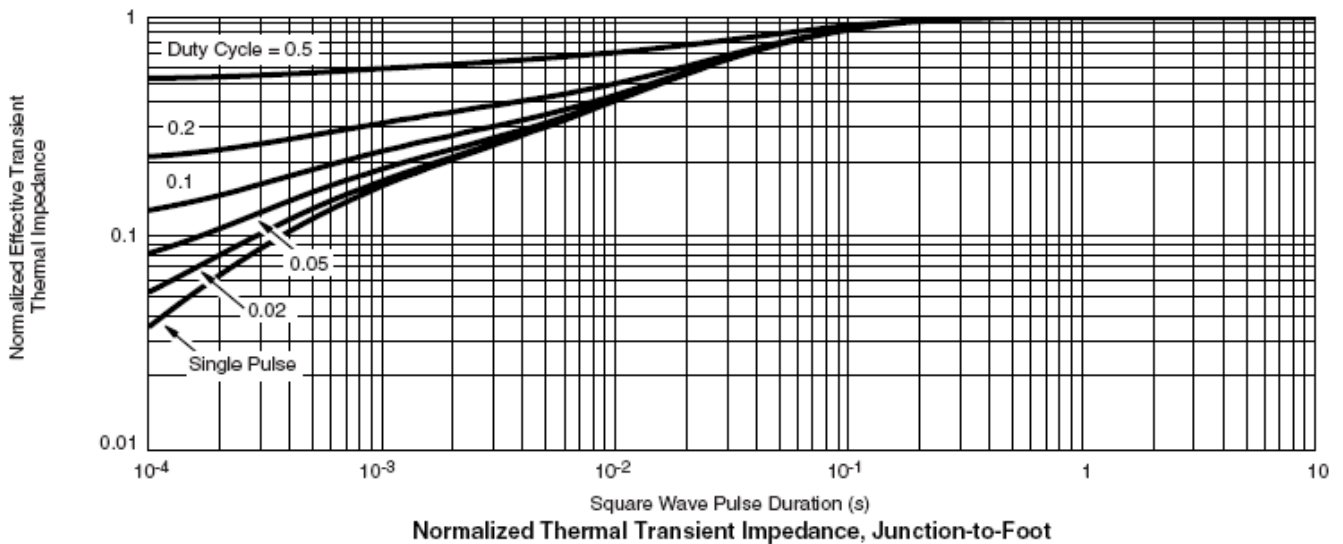
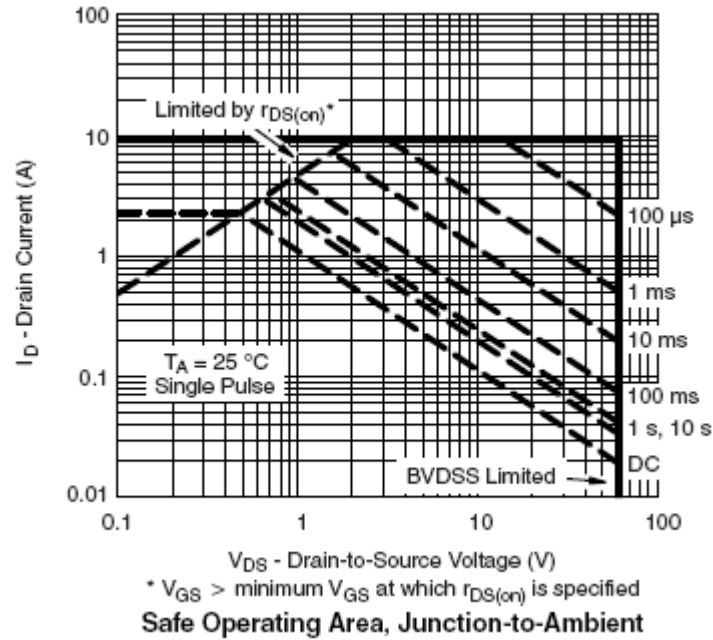




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### TYPICAL CHARACTERISTICS





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